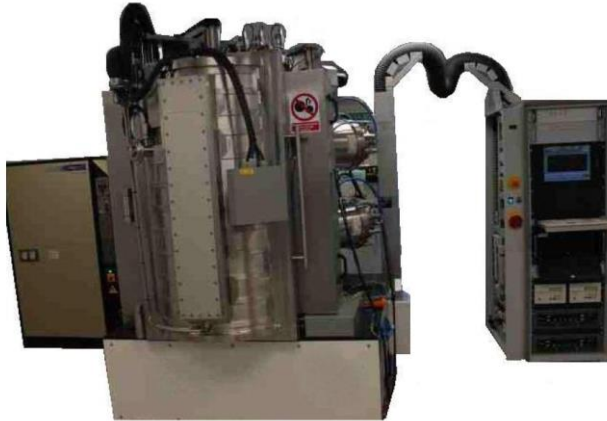


CFM850 Reactive Closed Field Magnetron Sputtering System

CHAMBER

Single walled, vertical axis, stainless steel, water cooled (or heated) via trace cooling channels. Access is by means of a hinged front opening door. Multiple ports for location of the rectangular magnetron sources.



- Chamber diameter (internal) 760mm
- Chamber height (internal) 1381mm
- Chamber diameter (external) 780mm
- Chamber height (external) 1451mm.
- Drum diameter 532mm
- Linear magnetron length 1055mm
- Magnetron width (target size) 133mm
- Magnetron positions: 4
- Available coating area ($\pm 1\%$): 11,130 cm²

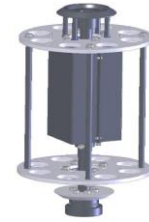
Further ports in the chamber walls are included as follows:

- 2 - view ports, 2" diameter.
- 1 - 70FC flanged port, to accommodate a mass Spectrometer.
- 5 - NW25 flanged ports
- 4 - NW10 flanged ports.

For all systems, one set of removable shields are included to simplify chamber periodic chamber cleaning.

DRUM SUBSTRATE CARRIER

CFM systems are equipped with a precision single axis drum with fixturing to accommodate a range of substrate sizes. The substrates are rotated at typically 50 rpm. This ensures $< \pm 1\%$ thickness uniformity over the central drum surface. One universal precision drum with shutter is supplied – drum shown with shutter removed:



Universal drum configuration

Segment sizes are interchangeable. Specific segment widths to be agreed with the customer. Cylindrical drum geometries are available for coating of flexible sheet.

A cylindrical drum for sheet loading in a CFM850 is shown as follows:



MAGNETRON SPUTTER SOURCES

Four magnetron positions are available. Two magnetrons are supplied as standard. The magnetrons are designed to produce intense ion bombardment of the substrates during deposition. The magnetrons are arranged in the patented closed field magnetron configuration (CFM).

The systems enable coating deposition to be carried out using a high density of low energy bombarding ions at room temperature. This results in deposition of very dense, non-columnar coating structures with low internal stresses. The use of a low bias voltage during deposition also allows deposition of coatings with dense structures at room temperature temperatures.

The ion bombardment power drawn by the substrates during ion cleaning is very much higher than that drawn during deposition which significantly increases the efficiency of ion cleaning resulting in coatings with very high levels of adhesion. The use and design of the CFM system is covered by the following patents: UK patent No. 2258343, European patent No. 0521045, US Patent No. 5554519, Japanese Patent No. 3397786.

VACUUM PUMPING SYSTEM

Backing pumps: Edwards E2M175 rotary pump and EH1200 roots blower combination.

Main chamber pumping: 2 X Edwards 2000l/s turbo pumps or equivalent.

Water vapor pumping: Telemark model TVP 3600 with dual meissner coils.

Note different pump suppliers can be used on customer request. The pumping sequence is automatically controlled.

VACUUM GAUGES

Pressure is monitored by a Penning/Pirani combination with an active gauge controller with digital display.

MAGNETRON POWER SUPPLIES

The two magnetrons are powered by two off Advanced Energy Pinnacle 10kW pulsed DC power supplies. These have excellent arc suppression and can operate on constant current, voltage or power. Power supplies can be run to allow simultaneous deposition from each magnetron.

GAS CONTROL

Two gas inlets are provided as standard, one for argon mass flow control and the other associated with the reactive gas control system. Gas lines are configured for two linear magnetrons although this can be extended to four magnetron positions on request.

Reactive gas flow is maintained at the appropriate rate by a gas controller monitoring magnetron. This system is used to control the exact composition and stoichiometry of reactively deposited coatings. A continuously tunable gate valve can be incorporated for real time active pressure control.

PROCESS CONTROL

The CFM650 system is supplied complete with fully automatic computer control.

The system can be monitored from the factory by internet link.

The computer fully controls the vacuum system and allows easy writing of coating sequences using the recipe writer section of the program.

The following data is logged and may be displayed;

- Magnetrons - current, voltage
- Bias - current, voltage
- Pressure – chamber and backing pressure
- Time
- Rate of rise before run
- Gas type and flows

A trending screen is displayed during the process, the data that is displayed is chosen by the operator and can be changed during the process if required. Once the run has finished, the data is logged in a spreadsheet format file. The process recipe is then attached to the end.

Recipe editing for single and multilayer layer deposition is available. This includes substrate cleaning, target conditioning stages, magnetron stabilization, deposition and shutdown.

WARRANTIES

All bought out items will carry the original manufacturer's warranty. This includes pumps, Power Supplies, Controllers, etc. All other items are warranted by Applied Multilayers LLC and any defect in materials or workmanship reported within one year of purchase will be repaired or replaced free of charge.

SPARES

A comprehensive spares list is provided. We stock most major items and will supply replacement parts by air transport on notification of breakdown. This will be a free service under the warranty for the first year, but will be charged after the end of the warranty period.

INSTALLATION REQUIREMENTS

415V AC, 3 phase supply, 45kW total. Water cooling flow 20 liters/minute, pressure 3 bar; 18°C. Compressed air at 100 psi, clean, dry and filtered. Research grade Argon and Oxygen.

